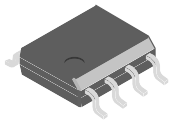
3.3 V LVDS, 2-Bit, High-Speed, Differential Driver

FIN1027A



SOIC8
CASE 751EB

General Description

This dual driver is designed for high−speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The driver translates LVTTL signal levels to LVDS levels with a typical differential output swing of 350 mV, which provides low EMI at ultra−low power dissipation, even at high frequencies. This device is ideal for high−speed transfer of clock or data.

The FIN1027A can be paired with its companion receiver, the FIN1028, or with any other LVDS receiver

Features

- Greater than 600 Mbs Data Rate
- 3 V Power Supply Operation
- 5 ns Maximum Differential Pulse Skew
- 1.5 ns Maximum Propagation Delay
- Low Power Dissipation
- Power−Off Protection
- Meets or Exceeds the TIA/EIA−644 LVDS Standard
- Flow−through Pinout Simplifies PCB Layout
- This Device is Pb−Free, Halide Free and is RoHS Compliant

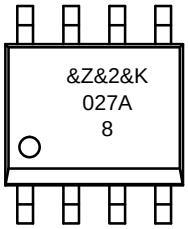
PIN CONFIGURATION

Name	Pin#	Description
V_{CC}	1	Power Supply
D_{IN1}	2	LVTTL Data Input
D_{IN2}	3	LVTTL Data Input
GND	4	Ground
D_{OUT2-}	5	Inverting Driver Output
D_{OUT2+}	6	Non−Inverting Driver Output
D_{OUT1+}	8	Non−Inverting Driver Output
D_{OUT1-}	7	Inverting Driver Output

FUNCTIONAL TABLE

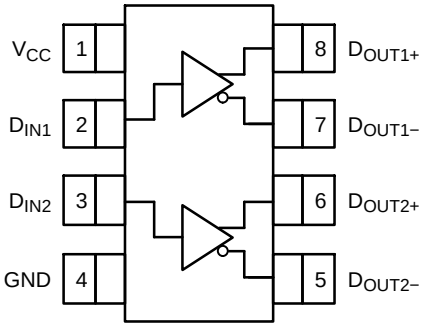
Input	Outputs	
D_{IN}	D_{OUT+}	D_{OUT-}
LOW	LOW	HIGH
HIGH	HIGH	LOW
OPEN	LOW	HIGH

MARKING DIAGRAM



&Z = Assembly Plant Code
&2 = 2−Digit Date Code
&K = 2−Digits Lot Run Traceability Code
027A8 = Specific Device Code

PIN CONFIGURATION



Top View

ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

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ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min	Max	Unit
V_{CC}	Supply Voltage	−0.5	4.6	V
D_{IN}	DC Input Voltage	−0.5	6.0	V
D_{OUT}	DC Output Voltage	−0.5	4.7	V
I_{OSD}	Driver Short−Circuit Current	Continuous		mA
T_{STG}	Storage Temperature Range	−65	+150	°C
T_J	Maximum Junction Temperature	−	+150	°C
T_L	Lead Temperature, Soldering, 10 Seconds	−	+260	°C
ESD	Human Body Model, JESD22−A114	−	≥6500	V
	Machine Model, JESD22−A115	−	≥400	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CC}	Supply Voltage	3.0	3.6	V
V_{IN}	Input Voltage	0	V_{CC}	V
T_A	Operating Temperature	−40	+85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(All typical values are at T_A = 25°C and with V_{CC} = 3.3 V. Over−supply voltage and operating temperature ranges, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OD}	Output Differential Voltage	R_L = 100 Ω, See Figure 1	250	350	450	mV
ΔV_{OD}	VOD Magnitude Change from Differential LOW−to−HIGH		−	−	25	mV
V_{OS}	Offset Voltage		1.125	1.250	1.375	V
ΔV_{OS}	Offset Magnitude Change from Differential LOW−to−HIGH		−	−	25	mV
I_{OFF}	Power−Off Output Current	V_{CC} = 0 V, V_{OUT} = 0 V or 3.6 V	−	−	±20	μA
I_{OS}	Short−Circuit Output Current	V_{OUT} = 0 V	−	−	−8	mA
		V_{OD} = 0 V	−	−	±8	
V_{IH}	Input HIGH Voltage		2.0	−	V_{CC}	V
V_{IL}	Input LOW Voltage		GND	−	0.8	V
I_{IN}	Input Current	V_{IN} = 0 V or V_{CC}	−	−	±20	μA
$I_{I(OFF)}$	Power−Off Input Current	V_{CC} = 0 V, V_{IN} = 0 V or 3.6 V	−	−	±20	μA
V_{IK}	Input Clamp Voltage	I_{IK} = −18 mA	−1.5	−	−	V
I_{CC}	Power Supply Current	No Load, V_{IN} = 0 V or V_{CC}	−	−	12.5	mA
		R_L = 100 Ω, V_{IN} = 0 V or V_{CC}	−	−	17.0	mA
C_{IN}	Input Capacitance		−	4	−	pF
C_{OUT}	Output Capacitance		−	6	−	pF

AC ELECTRICAL CHARACTERISTICS (All typical values are at T_A = 25°C and with V_{CC} = 3.3 V. Over−supply voltage and operating temperature ranges, unless otherwise specified.)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
t_{PLHD}	Differential Propagation Delay, LOW−to−HIGH	R_L = 100 Ω, CL = 10 pF, see Figure 2 and Figure 3	0.5	−	1.5	ns
t_{PHLD}	Differential Propagation Delay, HIGH−to−LOW		0.5	−	1.5	ns
t_{TLHD}	Differential Output Rise Time (20% to 80%)		0.4	−	1.0	ns
t_{THLD}	Differential Output Fall Time (80% to 20%)		0.4	−	1.0	ns
$t_{SK(P)}$	Pulse Skew $\|t_{PLH} - t_{PHL}\|$		−	−	0.5	ns
$t_{SK(LH)}$, $t_{SK(HL)}$	Channel−to−Channel Skew (Note 1)		−	−	0.3	ns
$t_{SK(PP)}$	Part−to−Part Skew (Note 2)		−	−	1.0	ns

1. $t_{SK(LH)}$, $t_{SK(HL)}$ is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same direction.
2. $t_{SK(PP)}$ is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW−to−HIGH or HIGH−to−LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.

TEST DIAGRAMS

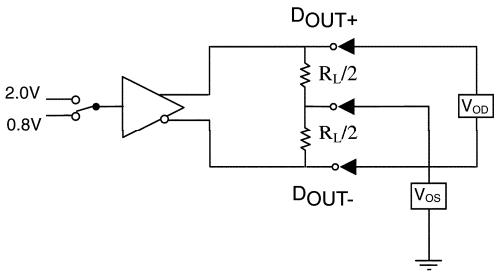
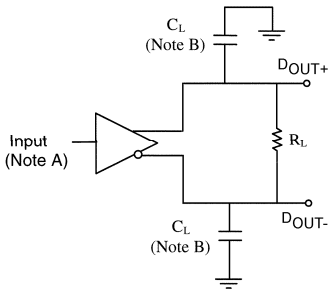


Figure 1. Differential Driver DC Test Circuit



NOTES:
A. All input pulses have frequency = 10 MHz, t_R or t_F = 2 ns.
B. C_L includes all probe and fixture capacitances.

Figure 2. Differential Driver Propagation Delay and Transition Time Test Circuit

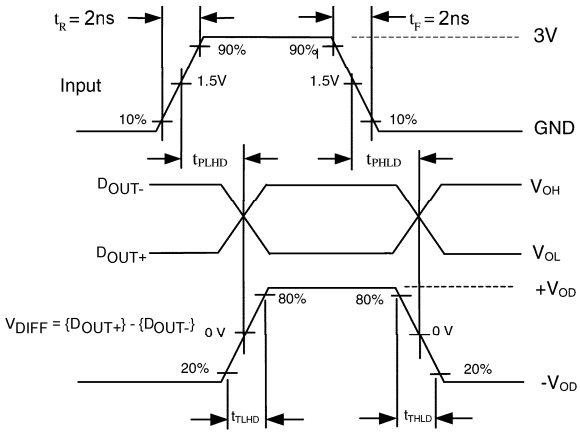


Figure 3. AC Waveforms

TYPICAL PERFORMANCE CHARACTERISTICS

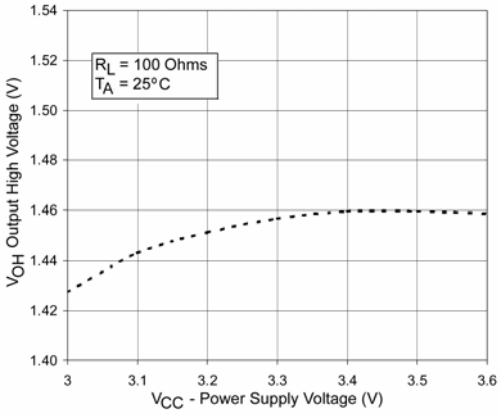


Figure 4. Output High Voltage vs. Power Supply Voltage

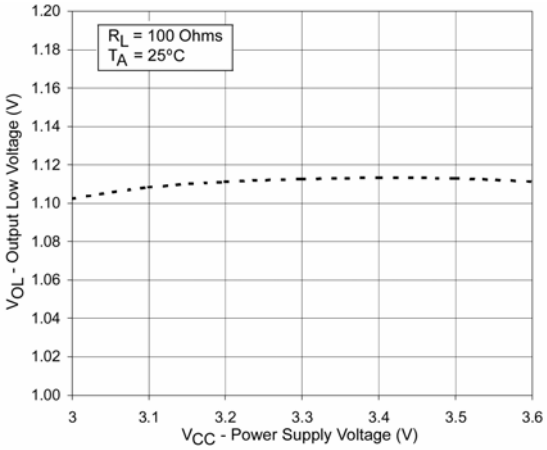


Figure 5. Output Low Voltage vs. Power Supply Voltage

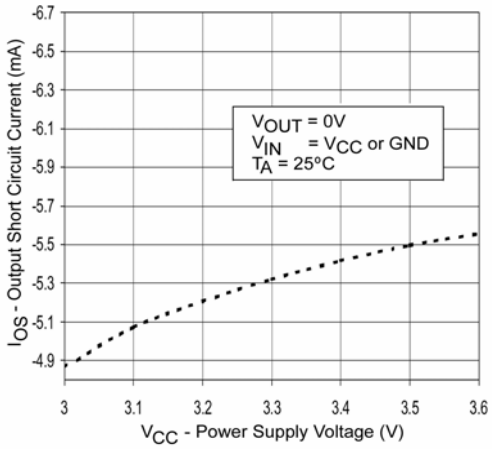


Figure 6. Output Short Circuit Current vs. Power Supply Voltage

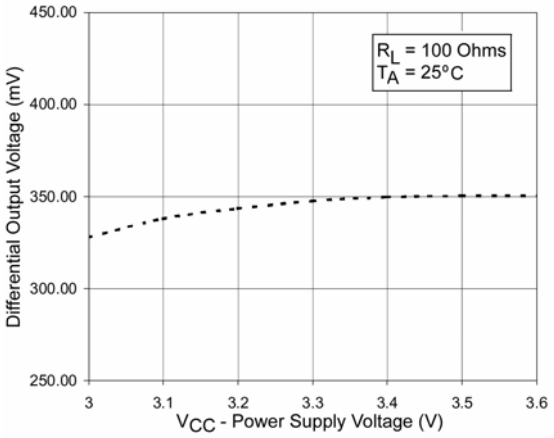


Figure 7. Differential Output Voltage vs. Power Supply Voltage

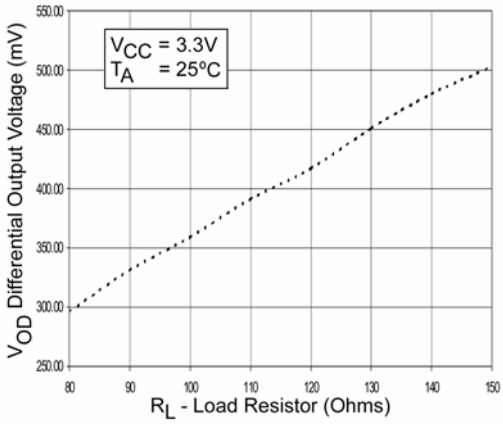


Figure 8. Differential Output Voltage vs. Load Resistor

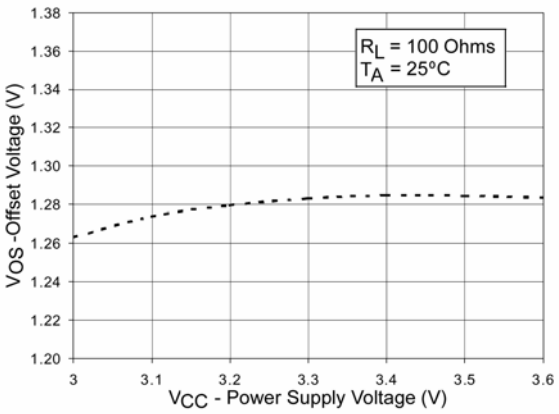


Figure 9. Offset Voltage vs. Power Supply Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

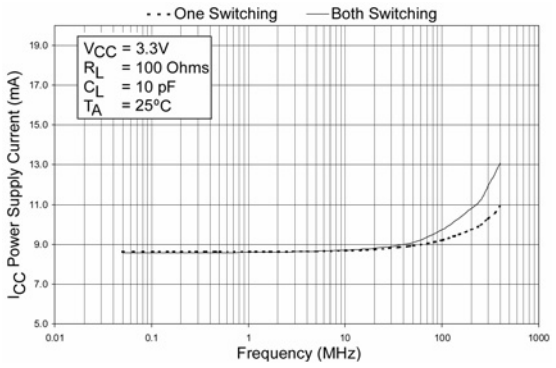


Figure 10. Power Supply Current vs. Frequency

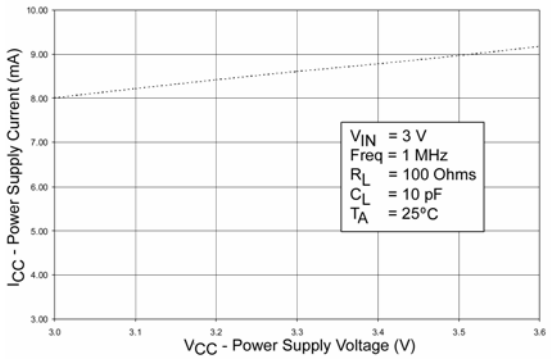


Figure 11. Power Supply Current vs. Power Supply Voltage

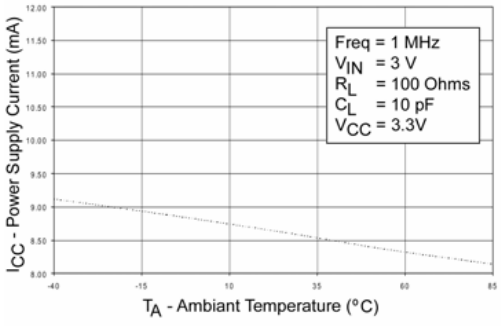


Figure 12. Power Supply Current vs. Ambient Temperature

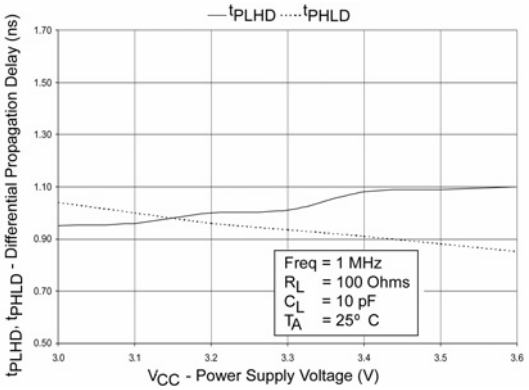


Figure 13. Differential Propagation Delay vs. Power Supply

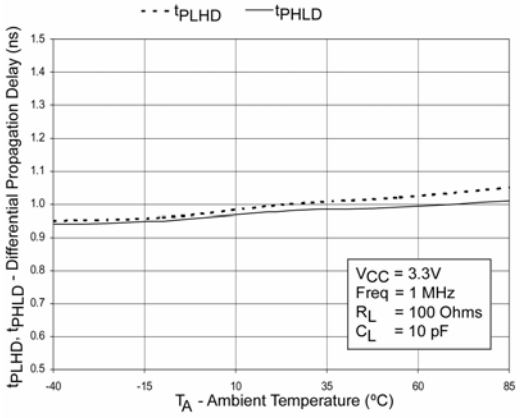


Figure 14. Differential Propagation Delay vs. Ambient Temperature

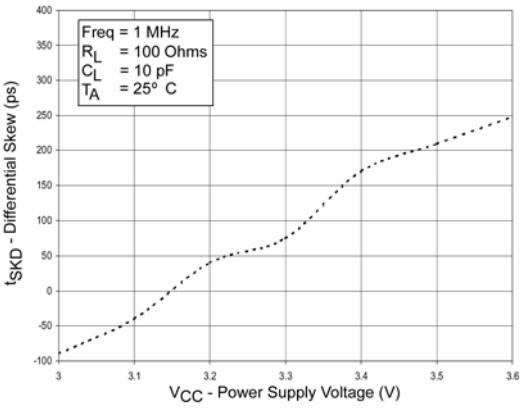


Figure 15. Differential Skew ($t_{PLH} - t_{PHL}$) vs. Power Supply

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

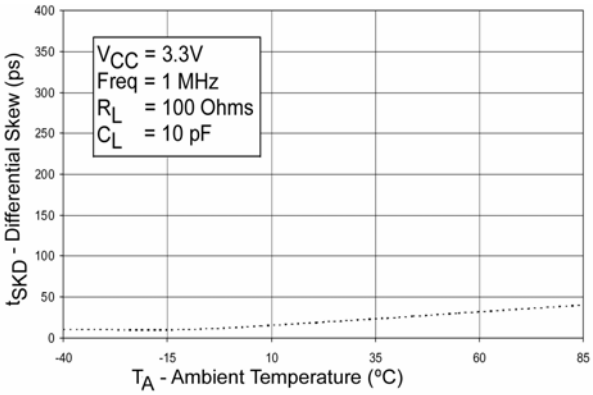


Figure 16. Differential Pulse Skew ($t_{PLH} - t_{PHL}$)

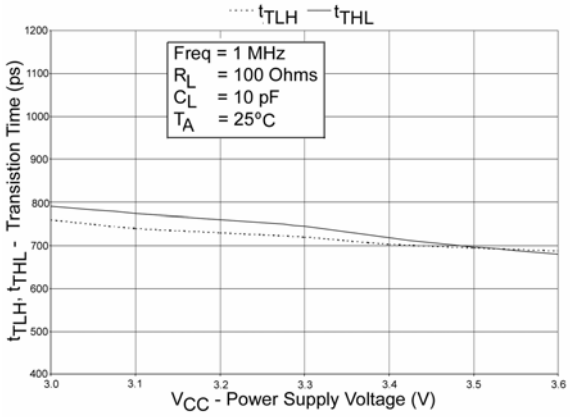


Figure 17. Transition Time vs. Power Supply Voltage

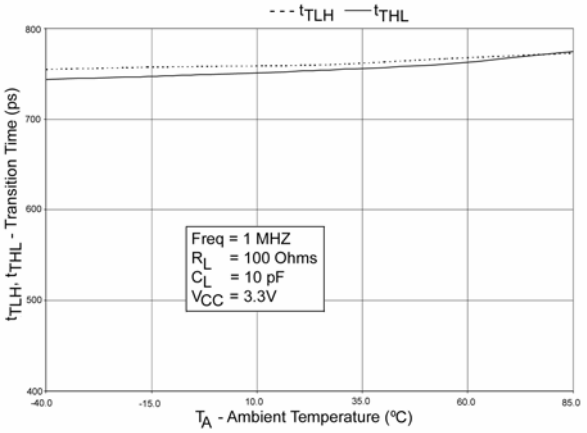


Figure 18. Transition Time vs. Ambient Temperature

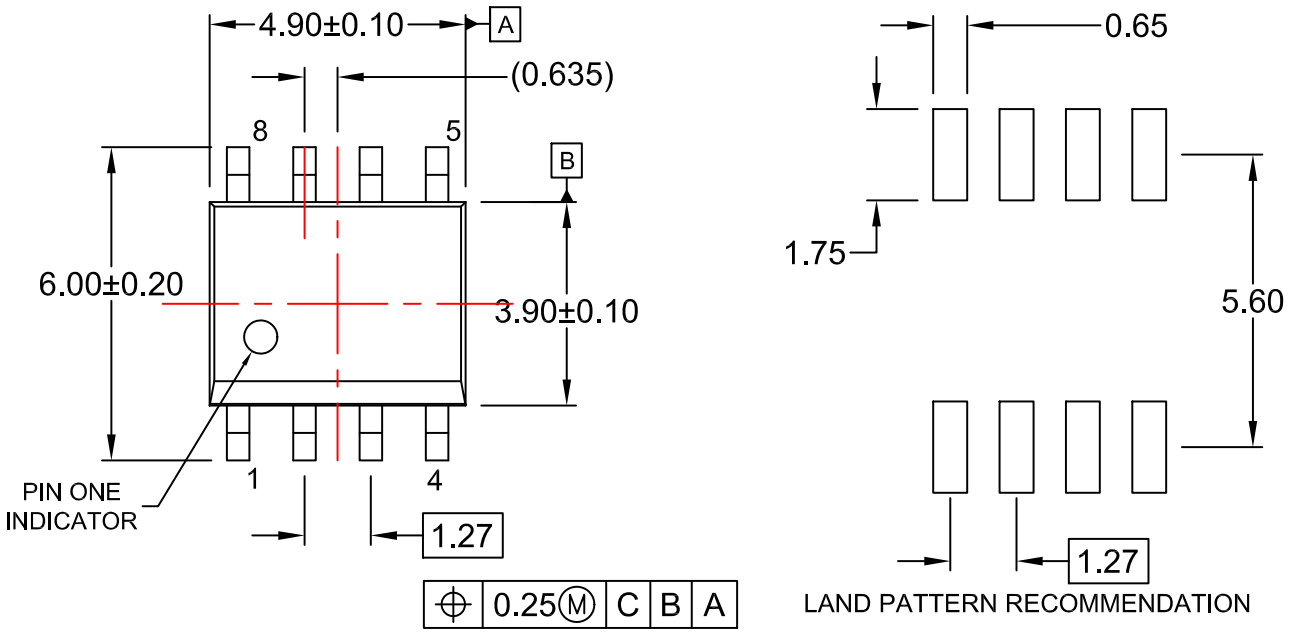
ORDERING INFORMATION

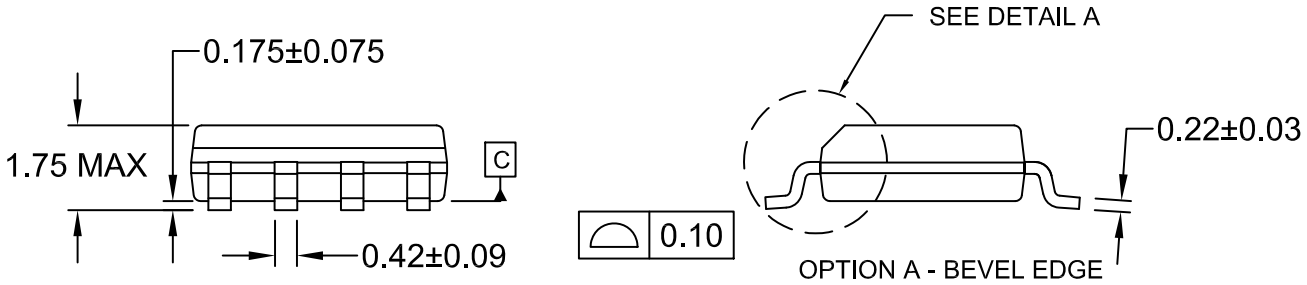
Part Number	Operating Range Temperature	Package	Shipping†
FIN1027AMX	−40 to +85°C	8−Lead Small Outline Package (SOIC), JEDEC MS−012, 0.150 inch Narrow (Pb−Free, Halide Free)	2500 / Tape & Reel

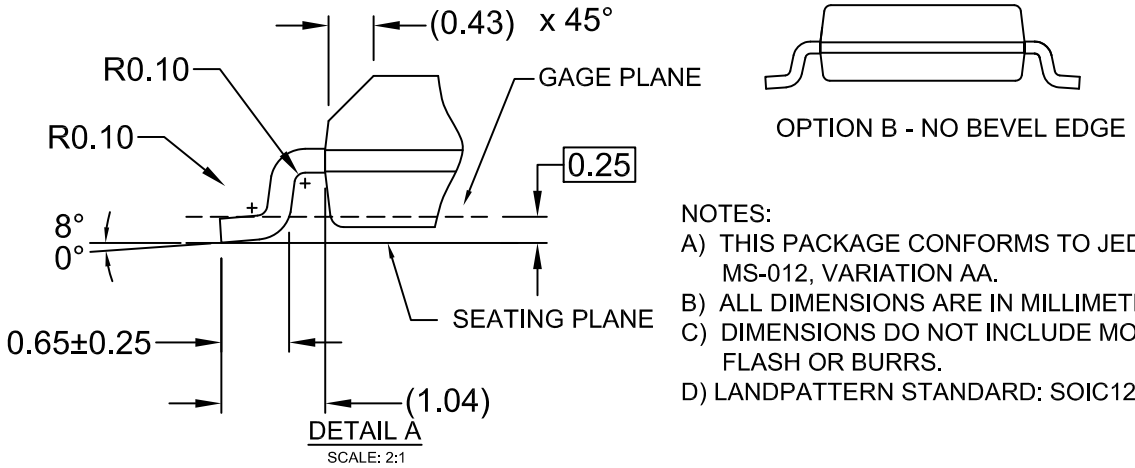
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SOIC8
CASE 751EB
ISSUE A

DATE 24 AUG 2017







NOTES:
A) THIS PACKAGE CONFORMS TO JEDEC MS-012, VARIATION AA.
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
D) LANDPATTERN STANDARD: SOIC127P600X175-8M

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